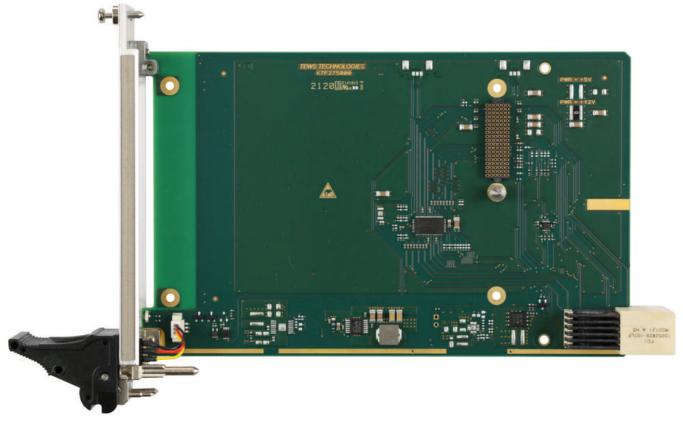


TCPS275 **3U CompactPCI Serial XMC Module Carrier**



TCPS275-10R

Application Information

The TCPS275 is a PICMG CPCI-S.0 R2.0 compatible 3U module that provides one slot for a single-width XMC module used to build modular, flexible and cost effective I/O solutions for all kinds of applications like process control, medical systems, telecommunication and traffic control.

The TCPS275 is a versatile solution to upgrade well known XMC I/O solutions to the CompactPCI Serial standard.

The PCI Express x4 link from the host board to the XMC module is enhanced by a PCIe Gen3 Redriver, allowing safe operation of XMC modules in distributed PCIe

The TCPS275 supports XMC front panel I/O.

VPWR is 12 V for all variants.

Technical Information

- Form Factor: 3U CPCI-S.0 R2.0
 - O Board size: 160 mm x 100 mm
- One XMC site conforming to VITA 42.3
 - O PCIe Interface: x4, Rev. 3.0
 - O 12 V VPWR
 - O XMC Front Panel I/O

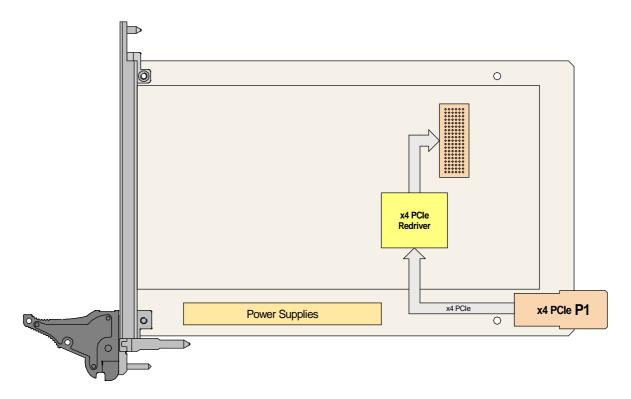
- O Operating temperature -40°C to +85°C
- O MTBF (MIL-HDBK217F/FN2 GB 20°C) TCPS275-10R: 1026000 h

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e-mail: info@tews.com www.tews.com





TCPS275-10R

Order Information

RoHS Compliant

TCPS275-10R 1 Slot Standard-XMC Carrier, PCle x4, VPWR = 12V

For the availability of TCPS275 variants with VITA61.0 connectors please contact TEWS.

Documentation

TCPS275-DOC User Manual